



Click [here](#) for the 3D model.

Dimensions

Chip Size	3040
L	7.6mm +/-0.4mm
W	10.2mm +/-0.4mm
T	1.4mm +/-0.15mm
S	4.2mm MIN
B	1.27mm +/-0.4mm

Packaging Specifications

Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	1000

General Information

Series	SMD Indust COG HVHT200C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable, Low Loss
Features	High Temp, Ultra-Stable, Low Loss
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
Termination	Lead (SnPb)
Marking	false
AEC-Q200	No
Typical Component Weight	500 mg
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.01 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	20%
Voltage DC	630 VDC
Dielectric Withstanding Voltage	945 VDC
Temperature Range	-55/+200°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms